

SOT1193-1

Plastic, extremely thin quad flat package; no leads; 8 terminals

8 February 2016

Package information

1. Package summary

Terminal position code Q (quad)
Package type descriptive code XQFN8
Package type industry code XQFN8

Package style descriptive code XQFN (extremely thin quad flatpack; no leads)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

IEC package outline code

JEDEC package outline code MO-255
JEITA package outline code ---

Mounting method type S (surface mount)

Issue date 2-11-2010

Table 1. Package summary

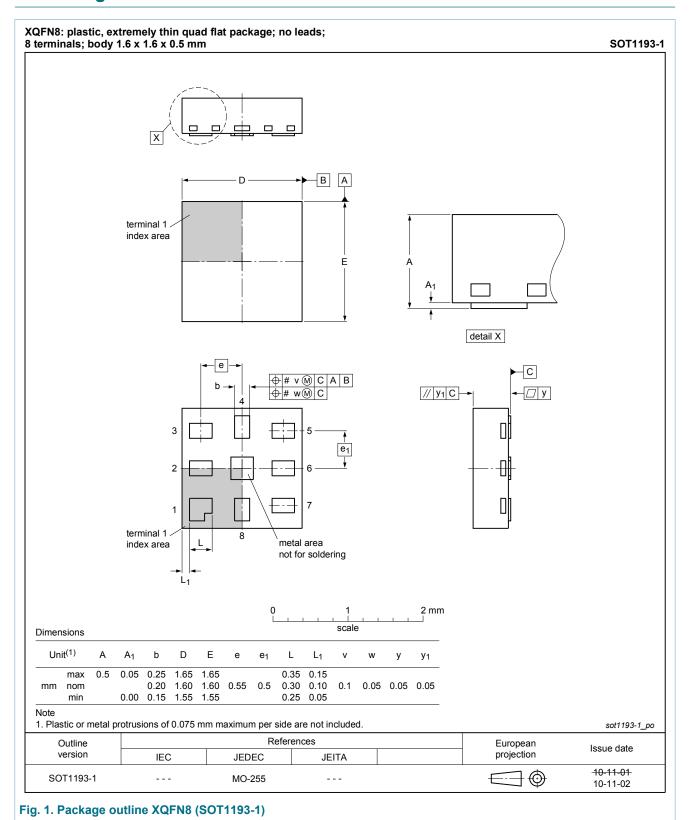
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	1.55	-	1.6	1.65	mm
E	package width	1.55	-	1.6	1.65	mm
Α	seated height	[tbd]	-	[tbd]	0.5	mm
е	nominal pitch	-	-	0.55	-	mm
n ₂	actual quantity of termination	-	-	8	-	



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2. Package outline



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3. Legal information

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